Memory Module Specifications



KF568C34BBK2-32

32GB (16GB 2G x 64-Bit x 2 pcs.)
DDR5-6800 CL34 288-Pin DIMM Kit



SPECIFICATIONS

CL(IDD)	40 cycles
Row Cycle Time (tRCmin)	48ns(min.)
Refresh to Active/Refresh Command Time (tRFCmin)	295ns(min.)
Row Active Time (tRASmin)	32ns(min.)
Row Active Time (tRASmin) UL Rating	32ns(min.) 94 V - 0
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DESCRIPTION

Kingston FURY KF568C34BBK2-32 is a kit of two 2G x 64-bit (16GB) DDR5-6800 CL34 SDRAM (Synchronous DRAM) 1Rx8, memory module, based on eight 2G x 8-bit FBGA components per module. Each module kit supports Intel® Extreme Memory Profiles (Intel® XMP) 3.0. Total kit capacity is 32GB. Each module has been tested to run at DDR5-6800 at a low latency timing of 34-45-45 at 1.4V. The SPDs are programmed to JEDEC standard latency DDR5-4800 timing of 40-39-39 at 1.1V. Each 288-pin DIMM uses gold contact fingers. The JEDEC standard electrical and mechanical specifications are as follows:

FEATURES

- Power Supply: VDD = 1.1V Typical
- VDDQ = 1.1V Typical
- VPP = 1.8V Typical
- VDDSPD = 1.8V to 2.0V
- On-Die ECC
- Height 1.37" (34.9mm), w/heatsink

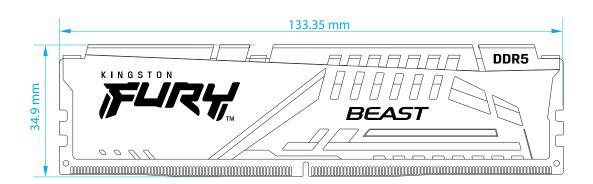
FACTORY TIMING PARAMETERS

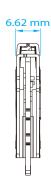
Default (JEDEC): DDR5-4800 CL40-39-39 @1.1V
 XMP Profile #1: DDR5-6800 CL34-45-45 @1.4V
 XMP Profile #2: DDR5-6400 CL32-39-39 @1.4V
 XMP Profile #3: DDR5-6000 CL30-36-36 @1.4V

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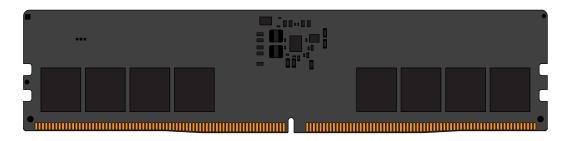


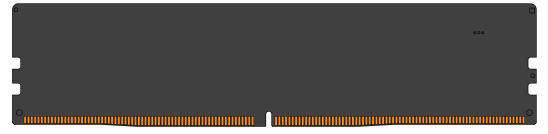
MODULE WITH HEAT SPREADER

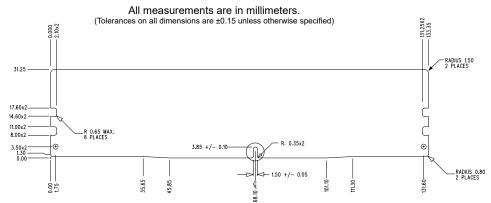




MODULE DIMENSIONS







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All Kingston products are tested to meet our published specifications. Some motherboards or system configurations may not operate at the published Kingston FURY memory speeds and timing settings. Kingston does not recommend that any user attempt to run their computers faster than the published speed. Overclocking or modifying your system timing may result in damage to computer components.



Revision No.	History	Release Date	Remark	Editor	Approved
Α	Initial Release	02/15/24		David Y.	Alex S.

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